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U.S. Patent Documents

<u>U.S. Patent No.</u>	<u>Publication Date</u>	<u>Patentee</u>
6,251,488	06/26/01	Miller et al.
6,259,962	07/10/01	Gothait
6,268,584	07/31/01	Keicher et al.
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6,562,661	05/13/03	Grigg

Other Documents

U.S. Patent Application Publication 2002/0171177 A1 to Kritchman et al., dated November 21, 2002

U.S. Patent Application Publication 2003/0151167 A1 to Kritchman et al., dated August 14, 2003

U.S. Patent Application Publication 2003/0176021 A1 to Grigg, dated September 18, 2003

MILLER et al., "Maskless Mesoscale Materials Deposition", Deposition Technology, September 2001, pages 20-22

MILLER, "New Laser-Directed Deposition Technology", Microelectronic Fabrication, August 2001, page 16

Webpage, Objet Prototyping the Future, "Objet FullCure700 Series", 1 page

Webpage, Objet Prototyping the Future, "How it Works", 2 pages

U.S. Patent Application No. 09/512,203, filed February 24, 2000, entitled "Tape Stiffener, Semiconductor Device Component Assemblies Including Same, and Stereolithographic Methods for Fabricating Same", inventor Ford B. Grigg

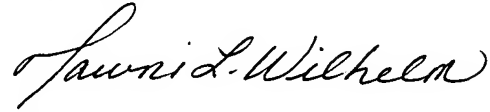
U.S. Patent Application No. 10/666,742, filed September 19, 2003, entitled "Support Structure for Thinning Semiconductor Substrates and Thinning Methods Employing the Support Structure", inventor Wood et al.

Applicants offer to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

Serial No. 10/666,930

This Supplemental Information Disclosure Statement is filed before the mailing date of a first Office Action on the merits.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "Tawni L. Wilhelm", written in a cursive style.

Tawni L. Wilhelm

Registration No. 47,456

Attorney for Applicant(s)

TRASKBRITT

P.O. Box 2550

Salt Lake City, Utah 84110-2550

Telephone: 801-532-1922

Date: January 5, 2004

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PTO/SB/08B(10-01)

Approved for use through 10/31/2002. OMB 0651-0031

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**INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**

(use as many sheets as necessary)

Sheet 2 of 2

Complete if Known

Application Number	10/666,930
Filing Date	September 19, 2003
First Named Inventor	Farnworth et al.
Group Art Unit	2812
Examiner Name	Unknown
Attorney Docket Number	5529UIS (02-0766 00/UIS)

OTHER PRIOR ART -- NON PATENT LITERATURE DOCUMENTS

Examiner Initials *	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
		U.S. Patent Application Publication 2002/0171177 A1 to Kritchman et al., dated November 21, 2002	
		U.S. Patent Application Publication 2003/0151167 A1 to Kritchman et al., dated August 14, 2003	
		U.S. Patent Application Publication 2003/0176021 A1 to Grigg, dated September 18, 2003	
		MILLER et al., "Maskless Mesoscale Materials Deposition", Deposition Technology, September 2001, pages 20-22	
		MILLER, "New Laser-Directed Deposition Technology", Microelectronic Fabrication, August 2001, page 16	
		Webpage, Objet Prototyping the Future, "Objet FullCure700 Series", 1 page	
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		U.S. Patent Application No. 09/512,203, filed February 24, 2000, entitled "Tape Stiffener, Semiconductor Device Component Assemblies Including Same, and Stereolithographic Methods for Fabricating Same", inventor Ford B. Grigg	
		U.S. Patent Application No. 10/666,742, filed September 19, 2003, entitled "Support Structure for Thinning Semiconductor Substrates and Thinning Methods Employing the Support Structure", inventor Wood et al.	

Examiner Signature		Date Considered	
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